#### NCE P-Channel Enhancement Mode Power MOSFET

#### **DESCRIPTION**

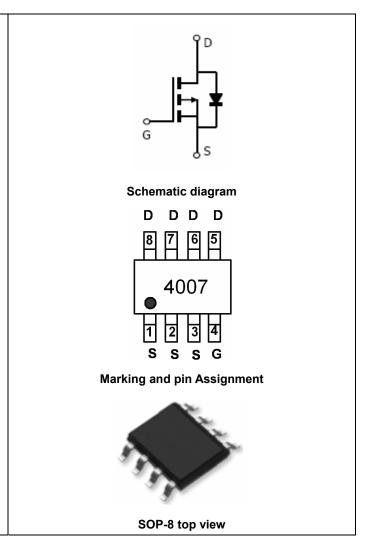
The NCE4007S uses advanced trench technology and design to provide excellent  $R_{DS(ON)}$  with low gate charge. It can be used in a wide variety of applications.

#### **GENERAL FEATURES**

- $V_{DS}$  =-40V, $I_{D}$  =-6.2A  $R_{DS(ON)}$  <25m $\Omega$  @  $V_{GS}$ =-10V
- High density cell design for ultra low Rdson
- Fully characterized Avalanche voltage and current
- Excellent package for good heat dissipation

#### **Application**

- Power switching application
- Hard Switched and High Frequency Circuits
- DC-DC Converter



#### **Package Marking And Ordering Information**

Device Marking	Device	Device Package	Reel Size	Tape width	Quantity
4007	NCE4007S	SOP-8	Ø330mm	12mm	2500 units

#### Absolute Maximum Ratings (TA=25℃unless otherwise noted)

Parameter	Symbol	Limit	Unit
Drain-Source Voltage	V <sub>DS</sub>	-40	V
Gate-Source Voltage	V <sub>G</sub> s	±20	V
Drain Current-Continuous	I <sub>D</sub>	-6.2	Α
Drain Current-Continuous(T <sub>C</sub> =100°C)	I <sub>D</sub> (100℃)	-4	Α
Pulsed Drain Current	I <sub>DM</sub>	40	Α
Maximum Power Dissipation	P <sub>D</sub>	2.5	W
Operating Junction and Storage Temperature Range	$T_{J},T_{STG}$	-55 To 150	$^{\circ}$

#### **Thermal Characteristic**

Thermal Resistance ,Junction-to-Ambient(Note 2)	R <sub>eJA</sub>	50	°C/W
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## Electrical Characteristics (TA=25°C unless otherwise noted)

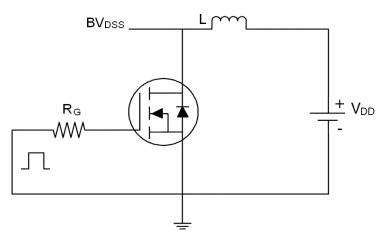
Parameter Symbol		Condition	Min	Тур	Max	Unit
Off Characteristics	<u>.</u>		•			
Drain-Source Breakdown Voltage	BV <sub>DSS</sub>	$V_{GS}=0V I_{D}=-250\mu A$ -40		-	-	V
Zero Gate Voltage Drain Current	I <sub>DSS</sub>	V <sub>DS</sub> =-40V,V <sub>GS</sub> =0V	-	-	1	μA
Gate-Body Leakage Current	te-Body Leakage Current I <sub>GSS</sub> V <sub>GS</sub> =±20V,V <sub>DS</sub> =0V		-	-	±100	nA
On Characteristics (Note 3)						
Gate Threshold Voltage	V <sub>GS(th)</sub>	V <sub>DS</sub> =V <sub>GS</sub> ,I <sub>D</sub> =-250μA	-1.1	-1.7	-2.5	V
Drain-Source On-State Resistance	R <sub>DS(ON)</sub>	V <sub>GS</sub> =-10V, I <sub>D</sub> =-5A	-	-	25	mΩ
Forward Transconductance	<b>g</b> FS	V <sub>DS</sub> =-5V,I <sub>D</sub> =-5A	20	-	-	S
Dynamic Characteristics (Note4)	<u>.</u>		•			
Input Capacitance	C <sub>lss</sub>	\/ - 20\/\/ -0\/	-	3000	-	PF
Output Capacitance	Coss	$V_{DS}$ =-20V, $V_{GS}$ =0V, F=1.0MHz	-	260	-	PF
Reverse Transfer Capacitance	C <sub>rss</sub>	F=1.UIVID2	-	180	-	PF
Switching Characteristics (Note 4)	<u>.</u>		•			
Turn-on Delay Time	t <sub>d(on)</sub>		-	9.5	-	nS
Turn-on Rise Time	t <sub>r</sub>	$V_{DD}$ =-20 $V$ , $R_L$ =2 $\Omega$	-	20	-	nS
Turn-Off Delay Time	t <sub>d(off)</sub>	$V_{GS}$ =-10V, $R_{GEN}$ =3 $\Omega$	-	55	-	nS
Turn-Off Fall Time	t <sub>f</sub>		-	30	-	nS
Total Gate Charge	Qg	\/ - 20\/   - 54	-	43	-	nC
Gate-Source Charge	Q <sub>gs</sub>	$V_{DS}$ =-20V, $I_{D}$ =-5A, $V_{GS}$ =-10V	-	7.5	-	nC
Gate-Drain Charge	$Q_{gd}$	V <sub>GS</sub> 10V	-	9	-	nC
Drain-Source Diode Characteristics						
Diode Forward Voltage (Note 3)	V <sub>SD</sub>	V <sub>GS</sub> =0V,I <sub>S</sub> =-6A	-	-	1.2	V
Diode Forward Current (Note 2)	Is		-	-	-6	Α
Reverse Recovery Time	t <sub>rr</sub>	TJ = 25°C, IF = -5A	-	-	38	nS
Reverse Recovery Charge	Qrr	di/dt = 100A/µs(Note3) 47		47	nC	
Forward Turn-On Time	t <sub>on</sub>	Intrinsic turn-on time is negligible (turn-on is dominated by LS+LD)				

#### Notes:

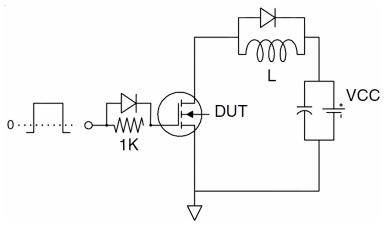
- 1. Repetitive Rating: Pulse width limited by maximum junction temperature.
- 2. Surface Mounted on FR4 Board, t ≤ 10 sec.
- **3.** Pulse Test: Pulse Width ≤ 300µs, Duty Cycle ≤ 2%.
- 4. Guaranteed by design, not subject to production

## **Test circuit**

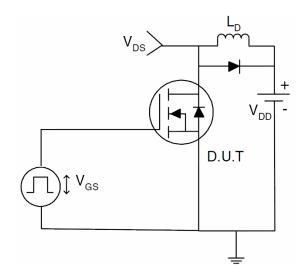
## 1) E<sub>AS</sub> test Circuits



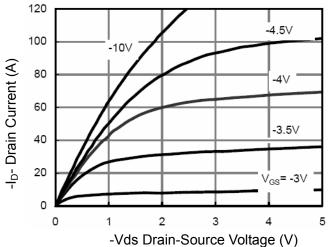
#### 2) Gate charge test Circuit:



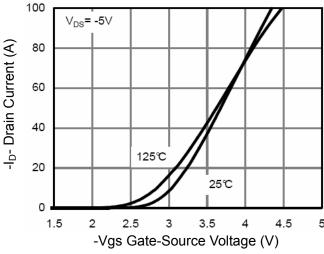
#### 3) Switch Time Test Circuit:



### TYPICAL ELECTRICAL AND THERMAL CHARACTERISTICS (Curves)



**Figure 1 Output Characteristics** 



**Figure 2 Transfer Characteristics** 

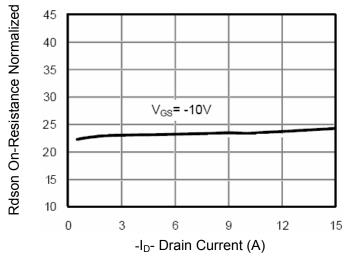


Figure 3 Rdson- Drain Current

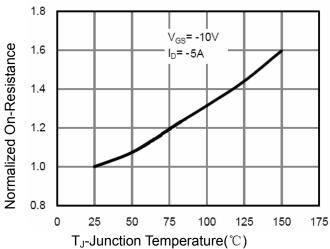


Figure 4 Rdson-JunctionTemperature

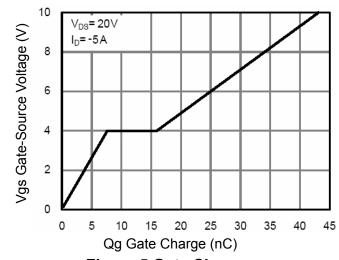


Figure 5 Gate Charge

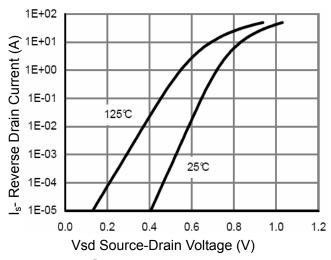


Figure 6 Source- Drain Diode Forward

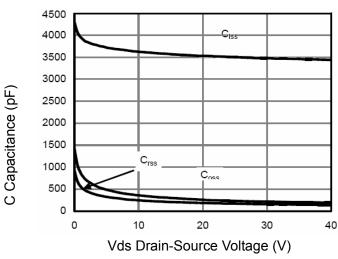


Figure 7 Capacitance vs Vds

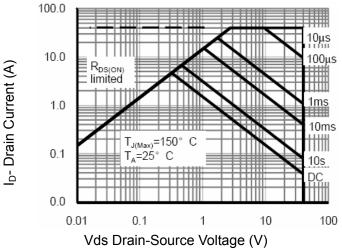


Figure 8 Safe Operation Area

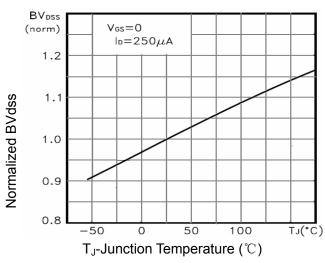


Figure 9 BV<sub>DSS</sub> vs Junction Temperature

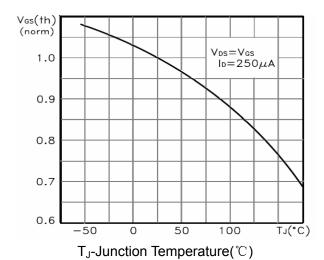
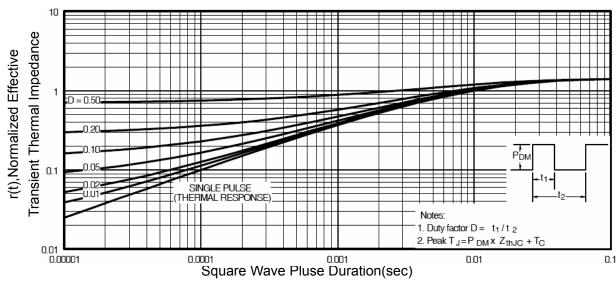
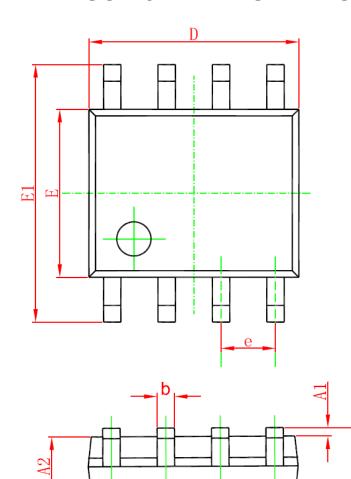


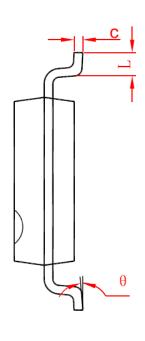
Figure 10 V<sub>GS(th)</sub> vs Junction Temperature



**Figure 11 Normalized Maximum Transient Thermal Impedance** 

# **SOP-8 PACKAGE IN FORMATION**





Cumbal	Dimensions In	n Millimeters	Dimensions In Inches		
Symbol	Min	Max	Min	Max	
A	1. 350	1. 750	0. 053	0. 069	
A1	0. 100	0. 250	0.004	0. 010	
A2	1. 350	1. 550	0.053	0. 061	
b	0. 330	0. 510	0. 013	0. 020	
С	0. 170	0. 250	0.006	0. 010	
D	4. 700	5. 100	0. 185	0. 200	
Е	3. 800	4. 000	0. 150	0. 157	
E1	5. 800	6. 200	0. 228	0. 244	
е	1. 270 (BSC)		0. 050 (BSC)		
L	0. 400	1. 270	0. 016	0. 050	
θ	0°	8°	0°	8°	

NCE4007S

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